

## 针对 2.4GHz 射频 (RF) 应用的片上系统

### 特性

- 射频 (RF) 部分
  - 单片 **2.4GHz RF** 收发器和微控制器 (MCU)
  - 支持 **250kbps, 500kbps, 1Mbps** 和 **2Mbps** 数据速率
  - 出色的链路预算, 无需外部前端即可实现长距离通信
  - 高达 **5dBm** 的可编程输出功率
  - 出色的接收器灵敏度 (**2Mbps** 时为 **-90Bm**, **256kbps** 时为 **-9dBm**)
  - 适用于符合世界范围内的射频标准的系统: **ETSI EN 300 328** 和 **EN 300 440 2** 类 (欧洲), **FCC CFR47 第 15 部分** (美国), 和 **ARIB STD-T66** (日本)
  - 精确的接收信号强度指示器 (RSSI) 功能
- 布局
  - 极少的外部组件
  - 适用于单层印刷电路板 (PCB) 应用的引脚引线
  - 提供参考设计
  - **32 引脚 5mm x 5mm** 四方扁平无引线 (QFN) (**16 通用 I/O 引脚**) 封装
- 低功率
  - 激活模式 **RX** 最佳性能: **21.2mA**
  - 激活模式 **TX (0dBm)**: **26mA**
  - 功率模式 **1 (5μs 唤醒)**: **235μA**
  - 功率模式 **2 (睡眠定时器打开)**: **0.9μA**
  - 功率模式 **3 (外部中断)**: **0.4μA**
  - 宽电源电压范围 (**2V 至 3.6V**)
  - 在所有功率模式下的完全 **RAM** 和寄存器保持
- 微控制器
  - 具有代码预取功能的高性能和低功率 **8051** 微控制器内核
  - **32KB** 闪存程序内存
  - **1KB SRAM**
  - 支持硬件调试
  - 扩展基带自动化, 包括自动确认和地址解码
- 外设
  - 可访问所有内存区域和外设的两个通道 **DMA**
  - 通用定时器 (**1 个 16 位, 2 个 8 位**)
  - 无线电定时器, **40 位**
  - 红外 (IR) 生成电路
  - 多个振荡器:
    - **32MHz** 晶体振荡器 (XOSC)
    - **16MHz RC** 振荡器 (RCOSC)
    - **32MHz RCOSC**
  - 具有捕捉功能的 **32kHz** 睡眠定时器
  - 高级加密标准 (AES) 安全协处理器
  - 通用异步收发器 (UART) / 串行外设接口 (SPI) / I<sup>2</sup>C 串行接口
  - **16 个通用 I/O 引脚 (3 x 20mA 驱动强度, 其余引脚有 4mA 的驱动强度)**
  - 安全装置定时器
  - 真随机数发生器
  - 模数转换器 (ADC) 和模拟比较器

### 应用范围

- 专有 **2.4 GHz** 系统
- 人机接口器件 (键盘、鼠标)
- 消费类电子产品



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

# CC2543

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这些装置包含有限的内置 ESD 保护。

存储或装卸时，应将导线一起截短或将装置放置于导电泡棉中，以防止 MOS 门极遭受静电损伤。

## 说明

CC2543 是一款经优化的针对数据速率高达 2Mbps 且使用低物料清单成本制造的片上系统 (SoC) 解决方案。

CC2543 将处于领先地位的 RF 收发器的出色性能与一个单周期 8051 兼容 CPU，32KB 系统内可编程闪存存储器，高达 1KB RAM，以及许多其它功能强大的特性组合在一起。CC2543 有高效的功率模式（RAM 和寄存器保持电流低于 1μA），这使得它非常适合应用于要求超低功耗的低占空比系统。运行模式间较短的转换时间进一步确保了低能耗。

CC2543 与 CC2541/CC2544/CC2545 兼容。它采用带有 SPI/UART/USB 接口的 5mm x 5mm QFN32 封装。供货时，CC2543 带有由德州仪器 (TI) 提供的完整参考设计。

此器件针对无线消费类产品和人机接口器件 (HID) 应用。CC2543 专为诸如无线鼠标的外设器件而设计。

方框图请见Figure 7。

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                            |                                                                                               | MIN  | MAX             | UNIT |
|----------------------------|-----------------------------------------------------------------------------------------------|------|-----------------|------|
| Supply voltage VDD         | All supply pins must have the same voltage                                                    | −0.3 | 3.9             | V    |
| Voltage on any digital pin |                                                                                               | −0.3 | VDD + 0.3 ≤ 3.9 | V    |
| Input RF level             |                                                                                               |      | 10              | dBm  |
| Storage temperature range  |                                                                                               | −40  | 125             | °C   |
| ESD <sup>(2)</sup>         | All pins, excluding 20 and 21, according to human-body model, JEDEC STD 22, method A114 (HBM) |      | 2.5             | kV   |
|                            | All pins, according to human-body model, JEDEC STD 22, method A114 (HBM)                      |      | 1.5             | kV   |
|                            | According to charged-device model, JEDEC STD 22, method C101 (CDM)                            |      | 750             | V    |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) **CAUTION:** ESD sensitive device. Precaution should be used when handling the device in order to prevent permanent damage.

## RECOMMENDED OPERATING CONDITIONS

|                                                     |                                        | MIN | MAX | UNIT |
|-----------------------------------------------------|----------------------------------------|-----|-----|------|
| Operating ambient temperature range, T <sub>A</sub> |                                        | −40 | 85  | °C   |
| Operating supply voltage VDD                        | All supply pins must have same voltage | 2   | 3.6 | V    |

## ELECTRICAL CHARACTERISTICS

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$  and  $V_{DD} = 3\text{ V}$ , unless otherwise noted.

| PARAMETER                                                                                                                      | TEST CONDITIONS                                                                                                                                                    | MIN | TYP  | MAX | UNIT          |
|--------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|---------------|
| <b>2 Mbps, GFSK, 320-kHz deviation</b>                                                                                         |                                                                                                                                                                    |     |      |     |               |
| $I_{\text{core}}$ – Core current consumption                                                                                   | RX mode, no peripherals active, low MCU activity                                                                                                                   |     | 21.2 |     | mA            |
|                                                                                                                                | TX mode, 0-dBm output power, no peripherals active, low MCU activity                                                                                               |     | 26   |     | mA            |
|                                                                                                                                | TX mode, 5-dBm output power, no peripherals active, low MCU activity                                                                                               |     | 29.4 |     | mA            |
|                                                                                                                                | Active mode, 16-MHz RCOSC, Low MCU activity                                                                                                                        |     | 3    |     | mA            |
|                                                                                                                                | Active mode, 32-MHz clock frequency, low MCU activity                                                                                                              |     | 6    |     | mA            |
|                                                                                                                                | Power mode 0, CPU clock halted, all peripherals on, no clock division, 32-MHz crystal selected                                                                     |     | 4.5  |     | mA            |
|                                                                                                                                | Power mode 0, CPU clock halted, all peripherals on, clock division at max (Limits max speed in peripherals except radio), 32-MHz crystal selected                  |     | 3.1  |     | mA            |
|                                                                                                                                | Power mode 1. Digital regulator on; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.753-kHz RCOSC, POR, BOD, and sleep timer active; RAM and register retention |     | 235  |     | $\mu\text{A}$ |
|                                                                                                                                | Power mode 2. Digital regulator off, 16 MHz RCOSC and 32 MHz crystal oscillator off; 32.753 kHz RCOSC, POR and sleep timer active; RAM and register retention      |     | 0.9  |     | $\mu\text{A}$ |
|                                                                                                                                | Power mode 3. Digital regulator off, no clocks, POR active; RAM and register retention                                                                             |     | 0.4  |     | $\mu\text{A}$ |
| $I_{\text{peri}}$ – Peripheral current consumption (Adds to core current $I_{\text{core}}$ for each peripheral unit activated) | Timer 1 (16-bit). Timer running, 32-MHz XOSC used                                                                                                                  |     | 90   |     | $\mu\text{A}$ |
|                                                                                                                                | Radio timer(40 bit). Timer running, 32-MHz XOSC used                                                                                                               |     | 90   |     | $\mu\text{A}$ |
|                                                                                                                                | Timer 3 (8-bit). Timer running, 32-MHz XOSC used                                                                                                                   |     | 60   |     | $\mu\text{A}$ |
|                                                                                                                                | Timer 4 (8-bit). Timer running, 32-MHz XOSC used                                                                                                                   |     | 70   |     | $\mu\text{A}$ |
|                                                                                                                                | Sleep timer. Including 32.753-kHz RCOSC                                                                                                                            |     | 0.6  |     | $\mu\text{A}$ |

## GENERAL CHARACTERISTICS

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$  and  $V_{DD} = 3\text{ V}$ , unless otherwise noted.

| PARAMETER                         | TEST CONDITIONS                                                                                                                                                                                            | MIN  | TYP | MAX  | UNIT          |
|-----------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-----|------|---------------|
| <b>WAKE-UP AND TIMING</b>         |                                                                                                                                                                                                            |      |     |      |               |
| Power mode 1 → Active             | Digital regulator ON, 16-MHz RCOSC and 32-MHz crystal oscillator OFF. Start-up of 16-MHz RCOSC                                                                                                             |      | 5   |      | $\mu\text{s}$ |
| Power mode 2 or 3 → Active        | Digital regulator OFF, 16 MHz RCOSC and 32 MHz crystal oscillator OFF. Start-up of regulator and 16 MHz RCOSC                                                                                              |      | 130 |      | $\mu\text{s}$ |
| Active → TX or RX                 | Crystal ESR = 16 $\Omega$ . Initially running on 16-MHz RCOSC, with 32-MHz XOSC OFF                                                                                                                        |      | 500 |      | $\mu\text{s}$ |
|                                   | With 32-MHz XOSC initially ON                                                                                                                                                                              |      | 180 |      | $\mu\text{s}$ |
| RX/TX turnaround                  | RCOSC, with 32MHz XOSC OFF                                                                                                                                                                                 |      | 130 |      | $\mu\text{s}$ |
| <b>RADIO PART</b>                 |                                                                                                                                                                                                            |      |     |      |               |
| RF frequency range                | Programmable in 1-MHz steps                                                                                                                                                                                | 2379 |     | 2496 | MHz           |
| Data rates and modulation formats | 2 Mbps, GFSK 320-kHz deviation<br>2-Mbps, GFSK 500 kHz deviation<br>1-Mbps, GFSK 250 kHz deviation<br>1-Mbps, GFSK 160 kHz deviation<br>500 kbps, MSK<br>250 kbps, GFSK 160 kHz deviation<br>250 kbps, MSK |      |     |      |               |

## RF RECEIVE SECTION

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$ , and  $f_c = 2440\text{ MHz}$ , unless otherwise noted.

| PARAMETER                                        | TEST CONDITIONS                                                                                                                                                                               | MIN  | TYP | MAX | UNIT |
|--------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-----|-----|------|
| <b>2 Mbps, GFSK, 320-kHz DEVIATION, 0.1% BER</b> |                                                                                                                                                                                               |      |     |     |      |
| Receiver sensitivity                             |                                                                                                                                                                                               |      | –86 |     | dBm  |
| Saturation                                       |                                                                                                                                                                                               |      | –8  |     | dBm  |
| Co-channel rejection                             | Wanted signal at –67 dBm                                                                                                                                                                      |      | –13 |     | dB   |
| In-band blocking rejection                       | $\pm 2$ -MHz offset, wanted signal at –67 dBm                                                                                                                                                 |      | –1  |     | dB   |
|                                                  | $\pm 4$ -MHz offset, wanted signal at –67 dBm                                                                                                                                                 |      | 34  |     |      |
|                                                  | $> \pm 6$ -MHz offset, wanted signal at –67 dBm                                                                                                                                               |      | 38  |     |      |
| Out-of-band blocking rejection                   | 1-MHz resolution. Wanted signal at –67 dBm, $f < 2\text{ GHz}$<br>Two exception frequencies with poorer performance                                                                           |      | –32 |     | dBm  |
|                                                  | 1-MHz resolution. Wanted signal at –67 dBm, $2\text{ GHz} > f < 3\text{ GHz}$<br>Two exception frequencies with poorer performance                                                            |      | –38 |     |      |
|                                                  | 1-MHz resolution. Wanted signal at –67 dBm, $f > 3\text{ GHz}$<br>Two exception frequencies with poorer performance                                                                           |      | –12 |     |      |
| Intermodulation                                  | Wanted signal at –64 dBm, 1 <sup>st</sup> interferer is CW, 2 <sup>nd</sup> interferer is GFSK-modulated signal. Offsets of interferers are:<br>6 and 12 MHz<br>8 and 16 MHz<br>10 and 20 MHz |      | –43 |     | dBm  |
| Frequency error tolerance <sup>(1)</sup>         | Including both initial tolerance and drift. Sensitivity better than –70 dBm. 250 byte payload.                                                                                                | –300 |     | 300 | kHz  |
| Symbol rate error tolerance <sup>(2)</sup>       | Sensitivity better than –70 dBm. 250 byte payload.                                                                                                                                            | –120 |     | 120 | ppm  |
| <b>2 Mbps, GFSK, 500 kHz DEVIATION, 0.1% BER</b> |                                                                                                                                                                                               |      |     |     |      |
| Receiver sensitivity                             |                                                                                                                                                                                               |      | –90 |     | dBm  |
| Saturation                                       |                                                                                                                                                                                               |      | –3  |     | dBm  |
| Co-channel rejection                             | Wanted signal at –67 dBm                                                                                                                                                                      |      | –10 |     | dB   |
| In-band blocking rejection                       | $\pm 2$ MHz offset, wanted signal at –67 dBm                                                                                                                                                  |      | –3  |     | dB   |
|                                                  | $\pm 4$ MHz offset, wanted signal at –67 dBm                                                                                                                                                  |      | 36  |     | dB   |
|                                                  | $> \pm 6$ MHz offset, wanted signal at –67 dBm                                                                                                                                                |      | 44  |     | dB   |
| Frequency error tolerance <sup>(1)</sup>         | Including both initial tolerance and drift. Sensitivity better than –70 dBm. 250 byte payload.                                                                                                | –300 |     | 300 | kHz  |
| Symbol rate error tolerance <sup>(2)</sup>       | Sensitivity better than –70 dBm. 250 byte payload.                                                                                                                                            | –120 |     | 120 | ppm  |
| <b>1 Mbps, GFSK, 250 kHz DEVIATION, 0.1% BER</b> |                                                                                                                                                                                               |      |     |     |      |
| Receiver sensitivity                             |                                                                                                                                                                                               |      | –94 |     | dBm  |
| Saturation                                       |                                                                                                                                                                                               |      | 6   |     | dBm  |
| Co-channel rejection                             | Wanted signal at –67 dBm                                                                                                                                                                      |      | –7  |     | dB   |
| In-band blocking rejection                       | $\pm 1$ MHz offset, wanted signal –67 dBm                                                                                                                                                     |      | 0   |     | dB   |
|                                                  | $\pm 2$ MHz offset, wanted signal –67 dBm                                                                                                                                                     |      | 30  |     |      |
|                                                  | $\pm 3$ MHz offset, wanted signal –67 dBm                                                                                                                                                     |      | 34  |     |      |
|                                                  | $> \pm 5$ MHz offset, wanted signal –67 dBm                                                                                                                                                   |      | 38  |     |      |
| Frequency error tolerance                        | Including both initial tolerance and drift. Sensitivity better than –70 dBm. 250 byte payload.                                                                                                | –250 |     | 250 | kHz  |
| Symbol rate error tolerance                      | Sensitivity better than –70 dBm. 250 byte payload.                                                                                                                                            | –80  |     | 80  | ppm  |

(1) Difference between center frequency of the received RF signal and local oscillator frequency

(2) Difference between incoming symbol rate and the internally generated symbol rate

## RF RECEIVE SECTION (continued)

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$ , and  $f_c = 2440\text{ MHz}$ , unless otherwise noted.

| PARAMETER                                           | TEST CONDITIONS                                                             | MIN  | TYP | MAX | UNIT |
|-----------------------------------------------------|-----------------------------------------------------------------------------|------|-----|-----|------|
| <b>1 Mbps, GFSK, 160 kHz DEVIATION, 0.1% BER</b>    |                                                                             |      |     |     |      |
| Receiver sensitivity                                |                                                                             |      | –91 |     | dBm  |
| Saturation                                          |                                                                             |      | 6   |     | dBm  |
| Co-channel rejection                                | Wanted signal at –67 dBm                                                    |      | –8  |     | dB   |
| In band blocking rejection                          | $\pm 1\text{ MHz}$ offset, wanted signal at –67 dBm                         |      | 2   |     | dB   |
|                                                     | $\pm 2\text{ MHz}$ offset, wanted signal at –67 dBm                         |      | 28  |     |      |
|                                                     | $\pm 3\text{ MHz}$ offset, wanted signal at –67 dBm                         |      | 33  |     |      |
|                                                     | $>\pm 5\text{ MHz}$ offset, wanted signal at –67 dBm                        |      | 36  |     |      |
| Frequency error tolerance                           | Including both initial tolerance and drift, Sensitivity better than –67 dBm | –250 |     | 250 | kHz  |
| Symbol rate error tolerance                         | Maximum packet length                                                       | –80  |     | 80  | ppm  |
| <b>500 kbps, MSK, 0.1% BER</b>                      |                                                                             |      |     |     |      |
| Receiver sensitivity                                |                                                                             |      | –98 |     | dBm  |
| Saturation                                          |                                                                             |      | 6   |     | dBm  |
| Co-channel rejection                                | Wanted signal at –67 dBm                                                    |      | –5  |     | dB   |
| In band blocking rejection                          | $\pm 1\text{ MHz}$ offset, wanted signal at –67 dBm                         |      | 21  |     | dB   |
|                                                     | $\pm 2\text{ MHz}$ offset, wanted signal at –67 dBm                         |      | 32  |     |      |
|                                                     | $>\pm 2\text{ MHz}$ offset, wanted signal at –67 dBm                        |      | 33  |     |      |
|                                                     |                                                                             |      |     |     |      |
| Frequency error tolerance                           | Including both initial tolerance and drift, Sensitivity better than –67dBm  | –150 |     | 150 | kHz  |
| Symbol rate error tolerance                         | Maximum packet length                                                       | –60  |     | 60  | ppm  |
| <b>250 kbps, GFSK, 160 kHz DEVIATION , 0.1% BER</b> |                                                                             |      |     |     |      |
| Receiver sensitivity                                |                                                                             |      | –98 |     | dBm  |
| Saturation                                          |                                                                             |      | 6   |     | dBm  |
| Co-channel rejection                                | Wanted signal at –67 dBm                                                    |      | –2  |     | dB   |
| In-band blocking rejection                          | $\pm 1\text{ MHz}$ offset, wanted signal at –67 dBm                         |      | 22  |     | dB   |
|                                                     | $\pm 2\text{ MHz}$ offset, wanted signal at –67 dBm                         |      | 32  |     |      |
|                                                     | $>\pm 2\text{ MHz}$ offset, wanted signal at –67 dBm                        |      | 32  |     |      |
|                                                     |                                                                             |      |     |     |      |
| Frequency error tolerance                           | Including both initial tolerance and drift, Sensitivity better than –67 dBm | –150 |     | 150 | kHz  |
| Symbol rate error tolerance                         | Maximum packet length                                                       | –60  |     | 60  | ppm  |
| <b>250 kbps, MSK, 0.1% BER</b>                      |                                                                             |      |     |     |      |
| Receiver sensitivity                                |                                                                             |      | –98 |     | dBm  |
| Saturation                                          |                                                                             |      | 6   |     | dBm  |
| Co-channel rejection                                | Wanted signal at –67 dBm                                                    |      | –5  |     | dB   |
| In-band blocking rejection                          | $\pm 1\text{ MHz}$ offset, wanted signal at –67 dBm                         |      | 21  |     | dB   |
|                                                     | $\pm 2\text{ MHz}$ offset, wanted signal at –67 dBm                         |      | 32  |     |      |
|                                                     | $>2\text{ MHz}$ offset, wanted signal at –67 dBm                            |      | 33  |     |      |
|                                                     |                                                                             |      |     |     |      |
| Frequency error tolerance                           | Including both initial tolerance and drift, Sensitivity better than –67 dBm | –150 |     | 150 | kHz  |
| Symbol rate error tolerance                         | Maximum packet length                                                       | –60  |     | 60  | ppm  |
| <b>ALL RATES/FORMATS</b>                            |                                                                             |      |     |     |      |
| Spurious emission in RX.<br>Conducted measurement   | $f < 1\text{ GHz}$                                                          |      | –67 |     | dBm  |
| Spurious emission in RX.<br>Conducted measurement   | $f > 1\text{ GHz}$                                                          |      | –60 |     | dBm  |

## CC2543

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### RF TRANSMIT SECTION

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$ , and  $f_c = 2440\text{ MHz}$ , unless otherwise noted.

| PARAMETER                                         | TEST CONDITIONS                                                                                                                                                                         | MIN | TYP | MAX | UNIT |
|---------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| Output power, maximum setting                     | Delivered to a single-ended 50- $\Omega$ load through a balun using maximum recommended output power setting.                                                                           |     | 5   |     | dBm  |
| Output power, minimum setting                     | Delivered to a single-ended 50- $\Omega$ load through a balun using minimum recommended output power setting.                                                                           |     | –20 |     | dBm  |
| Programmable output power range                   | Delivered to a single-ended 50- $\Omega$ load through a balun.                                                                                                                          |     | 25  |     | dB   |
| Spurious emission in TX.<br>Conducted measurement | $f < 1\text{ GHz}$                                                                                                                                                                      |     | –46 |     | dBm  |
|                                                   | $f > 1\text{ GHz}$                                                                                                                                                                      |     | –46 |     | dBm  |
|                                                   | Suitable for Systems Targeting Compliance With Worldwide Radio Frequency Regulations: ETSI EN 300 328 and EN 300 440 Class 2 (Europe), FCC CFR47 Part 15 (US), and ARIB STD-T66 (Japan) |     |     |     |      |

Use a simple LC filter (1.6nH and 1.8pF in parallel to ground) to pass ETSI conducted requirements below 1GHz in restricted bands. For radiated measurements low antenna gain for these frequencies (depending on antenna design) can achieve the same attenuation of these low frequency components (see EM reference design).

### 32-MHz CRYSTAL OSCILLATOR

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$ , unless otherwise noted.

| PARAMETER                              | TEST CONDITIONS                                                                                                                                                                                                      | MIN               | TYP  | MAX            | UNIT     |
|----------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------|------|----------------|----------|
| Crystal frequency                      |                                                                                                                                                                                                                      |                   | 32   |                | MHz      |
| Crystal frequency accuracy requirement | 250 kbps and 500 kbps data rates<br>1 Mbps data rate<br>2 Mbps data rate                                                                                                                                             | –30<br>–40<br>–60 |      | 30<br>40<br>60 | ppm      |
| Equivalent series resistance           |                                                                                                                                                                                                                      | 6                 |      | 60             | $\Omega$ |
| Crystal shunt capacitance              |                                                                                                                                                                                                                      | 1                 |      | 7              | pF       |
| Crystal load capacitance               |                                                                                                                                                                                                                      | 10                |      | 16             | pF       |
| Start-up time                          |                                                                                                                                                                                                                      |                   | 0.25 |                | ms       |
| Power-down guard time                  | The crystal oscillator must be in power down for a guard time before it is used again. This requirement is valid for all modes of operation. The need for power-down guard time can vary with crystal type and load. | 3                 |      |                | ms       |

### 32-kHz RC OSCILLATOR

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$ , unless otherwise noted.

| PARAMETER                            | TEST CONDITIONS | MIN | TYP         | MAX | UNIT |
|--------------------------------------|-----------------|-----|-------------|-----|------|
| Calibrated frequency                 |                 |     | 32.753      |     | kHz  |
| Frequency accuracy after calibration |                 |     | $\pm 0.2\%$ |     |      |
| Temperature coefficient              |                 |     | 0.4         |     | %/°C |
| Supply-voltage coefficient           |                 |     | 3           |     | %/V  |
| Calibration time                     |                 |     | 2           |     | ms   |

### 16-MHz RC OSCILLATOR

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$ , unless otherwise noted.

| PARAMETER                            | TEST CONDITIONS | MIN | TYP         | MAX | UNIT          |
|--------------------------------------|-----------------|-----|-------------|-----|---------------|
| Calibrated frequency                 |                 |     | 16          |     | MHz           |
| Uncalibrated frequency accuracy      |                 |     | $\pm 18\%$  |     |               |
| Frequency accuracy after calibration |                 |     | $\pm 0.6\%$ |     |               |
| Start-up time                        |                 |     | 10          |     | $\mu\text{s}$ |
| Initial calibration time             |                 |     | 50          |     | $\mu\text{s}$ |

## RSSI CHARACTERISTICS

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$ , unless otherwise noted.

| <b>2Mbps, GFSK, 320-kHz Deviation, 0.1% BER and 2 Mbps, GFSK, 500-kHz Deviation, 0.1% BER</b> |                               |         |     |
|-----------------------------------------------------------------------------------------------|-------------------------------|---------|-----|
| RSSI range <sup>(1)</sup>                                                                     | Reduced gain by AC algorithm  | 64      | dB  |
|                                                                                               | High gain by AGC algorithm    | 64      |     |
| RSSI offset <sup>(1)</sup>                                                                    | Reduced gain by AGC algorithm | 79      | dBm |
|                                                                                               | High gain by AGC algorithm    | 99      |     |
| Absolute uncalibrated accuracy <sup>(1)</sup>                                                 |                               | $\pm 3$ | dB  |
| Step size (LSB value)                                                                         |                               | 1       | dB  |
| <b>All Other Rates/Formats</b>                                                                |                               |         |     |
| RSSI range <sup>(1)</sup>                                                                     |                               | 64      | dB  |
| RSSI offset <sup>(1)</sup>                                                                    |                               | 99      | dBm |
| Absolute uncalibrated accuracy                                                                |                               | $\pm 3$ | dB  |
| Step size (LSB value)                                                                         |                               | 1       | dB  |

(1) Assuming CC2543 EM reference design. Other RF designs give an offset from the reported value.

## FREQUENCY SYNTHESIZER CHARACTERISTICS

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$ , unless otherwise noted.

| PARAMETER                        | TEST CONDITIONS                    | MIN | TYP  | MAX | UNIT   |
|----------------------------------|------------------------------------|-----|------|-----|--------|
| Phase noise, unmodulated carrier | At $\pm 1\text{ MHz}$ from carrier |     | –112 |     | dBc/Hz |
|                                  | At $\pm 3\text{ MHz}$ from carrier |     | –119 |     |        |
|                                  | At $\pm 5\text{ MHz}$ from carrier |     | –122 |     |        |

## ANALOG TEMPERATURE SENSOR

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$  unless otherwise noted

| PARAMETER                            | TEST CONDITIONS                                                                            | MIN | TYP      | MAX | UNIT                |
|--------------------------------------|--------------------------------------------------------------------------------------------|-----|----------|-----|---------------------|
| Output                               | Measured using integrated ADC, internal band-gap voltage reference, and maximum resolution |     | 1480     |     | 12-bit              |
| Temperature coefficient              |                                                                                            |     | 4.5      |     | / $1^\circ\text{C}$ |
| Voltage coefficient                  |                                                                                            |     | 1        |     | / $0.1\text{ V}$    |
| Initial accuracy without calibration |                                                                                            |     | $\pm 10$ |     | $^\circ\text{C}$    |
| Accuracy using 1-point calibration   |                                                                                            |     | $\pm 5$  |     | $^\circ\text{C}$    |
| Current consumption when enabled     |                                                                                            |     | 0.5      |     | mA                  |

## COMPARATOR CHARACTERISTICS

$T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{ V}$ . All measurement results are obtained using the CC2543 reference designs, post-calibration.

| PARAMETER                   | TEST CONDITIONS | MIN | TYP      | MAX | UNIT                         |
|-----------------------------|-----------------|-----|----------|-----|------------------------------|
| Common-mode maximum voltage |                 |     | $V_{DD}$ |     | V                            |
| Common-mode minimum voltage |                 |     | –0.3     |     |                              |
| Input offset voltage        |                 |     | 1        |     | mV                           |
| Offset vs temperature       |                 |     | 16       |     | $\mu\text{V}/^\circ\text{C}$ |
| Offset vs operating voltage |                 |     | 4        |     | mV/V                         |
| Supply current              |                 |     | 230      |     | nA                           |
| Hysteresis                  |                 |     | 0.15     |     | mV                           |

## ADC CHARACTERISTICS

 $T_A = 25^\circ\text{C}$  and  $V_{DD} = 3\text{ V}$ 

| PARAMETER           |                                         | TEST CONDITIONS                                                                    | MIN | TYP   | MAX | UNIT          |
|---------------------|-----------------------------------------|------------------------------------------------------------------------------------|-----|-------|-----|---------------|
|                     | Input voltage                           | VDD is voltage from supply                                                         | 0   |       | VDD | V             |
|                     | External reference voltage              | VDD is voltage from supply                                                         | 0   |       | VDD | V             |
|                     | External reference voltage differential | VDD is voltage from supply                                                         | 0   |       | VDD | V             |
|                     | Input resistance, signal                | Simulated using 4-MHz clock speed                                                  |     | 197   |     | k $\Omega$    |
|                     | Full-scale signal <sup>(1)</sup>        | Peak-to-peak, defines 0 dBFS                                                       |     | 2.97  |     | V             |
| ENOB <sup>(1)</sup> | Effective number of bits                | Single-ended input, 7-bit setting                                                  |     | 5.7   |     | bits          |
|                     |                                         | Single-ended input, 9-bit setting                                                  |     | 7.5   |     |               |
|                     |                                         | Single-ended input, 10-bit setting                                                 |     | 9.3   |     |               |
|                     |                                         | Single-ended input, 12-bit setting                                                 |     | 10.3  |     |               |
|                     |                                         | Differential input, 7-bit setting                                                  |     | 6.5   |     |               |
|                     |                                         | Differential input, 9-bit setting                                                  |     | 8.3   |     |               |
|                     |                                         | Differential input, 10-bit setting                                                 |     | 10    |     |               |
|                     |                                         | Differential input, 12-bit setting                                                 |     | 11.5  |     |               |
|                     |                                         | 10-bit setting, clocked by RCOSC                                                   |     | 9.7   |     |               |
|                     |                                         | 12-bit setting, clocked by RCOSC                                                   |     | 10.9  |     |               |
|                     | Useful power bandwidth                  | 7-bit setting, both single and differential                                        |     | 0–20  |     | kHz           |
| THD                 | Total harmonic distortion               | Single ended input, 12-bit setting, –6 dBFS <sup>(1)</sup>                         |     | –75.2 |     | dB            |
|                     |                                         | Differential input, 12-bit setting, –6 dBFS <sup>(1)</sup>                         |     | –86.6 |     |               |
|                     | Signal to nonharmonic ratio             | Single-ended input, 12-bit setting <sup>(1)</sup>                                  |     | 70.2  |     | dB            |
|                     |                                         | Differential input, 12-bit setting <sup>(1)</sup>                                  |     | 79.3  |     |               |
|                     |                                         | Single-ended input, 12-bit setting, –6 dBFS <sup>(1)</sup>                         |     | 78.8  |     |               |
|                     |                                         | Differential input, 12-bit setting, –6 dBFS <sup>(1)</sup>                         |     | 88.9  |     |               |
| CMRR                | Common-mode rejection ratio             | Differential input, 12-bit setting, 1-kHz sine (0 dBFS), limited by ADC resolution |     | >84   |     | dB            |
|                     | Crosstalk                               | Single ended input, 12-bit setting, 1-kHz sine (0 dBFS), limited by ADC resolution |     | >84   |     | dB            |
|                     | Offset                                  | Midscale                                                                           |     | –3    |     | mV            |
|                     | Gain error                              |                                                                                    |     | 0.68% |     |               |
| DNL                 | Differential nonlinearity               | 12-bit setting, mean <sup>(1)</sup>                                                |     | 0.05  |     | LSB           |
|                     |                                         | 12-bit setting, maximum <sup>(1)</sup>                                             |     | 0.9   |     |               |
| INL                 | Integral nonlinearity                   | 12-bit setting, mean <sup>(1)</sup>                                                |     | 4.6   |     | LSB           |
|                     |                                         | 12-bit setting, maximum <sup>(1)</sup>                                             |     | 13.3  |     |               |
|                     |                                         | 12-bit setting, mean, clocked by RCOSC                                             |     | 10    |     |               |
|                     |                                         | 12-bit setting, max, clocked by RCOSC                                              |     | 29    |     |               |
| SINAD<br>(–THD+N)   | Signal-to-noise-and-distortion          | Single ended input, 7-bit setting <sup>(1)</sup>                                   |     | 35.4  |     | dB            |
|                     |                                         | Single ended input, 9-bit setting <sup>(1)</sup>                                   |     | 46.8  |     |               |
|                     |                                         | Single ended input, 10-bit setting <sup>(1)</sup>                                  |     | 57.5  |     |               |
|                     |                                         | Single ended input, 12-bit setting <sup>(1)</sup>                                  |     | 66.6  |     |               |
|                     |                                         | Differential input, 7-bit setting <sup>(1)</sup>                                   |     | 40.7  |     |               |
|                     |                                         | Differential input, 9-bit setting <sup>(1)</sup>                                   |     | 51.6  |     |               |
|                     |                                         | Differential input, 10-bit setting <sup>(1)</sup>                                  |     | 61.8  |     |               |
|                     |                                         | Differential input, 12-bit setting <sup>(1)</sup>                                  |     | 70.8  |     |               |
|                     | Conversion time                         | 7-bit setting                                                                      |     | 20    |     | $\mu\text{s}$ |
|                     |                                         | 9-bit setting                                                                      |     | 36    |     |               |
|                     |                                         | 10-bit setting                                                                     |     | 68    |     |               |
|                     |                                         | 12-bit setting                                                                     |     | 132   |     |               |

(1) Measured with 300-Hz sine-wave input and VDD as reference.



## ADC CHARACTERISTICS (continued)

 $T_A = 25^{\circ}\text{C}$  and  $V_{DD} = 3\text{ V}$ 

| PARAMETER                                  | TEST CONDITIONS | MIN | TYP  | MAX | UNIT                     |
|--------------------------------------------|-----------------|-----|------|-----|--------------------------|
| Power consumption                          |                 |     | 1.2  |     | mA                       |
| Internal reference VDD coefficient         |                 |     | 4    |     | mV/V                     |
| Internal reference temperature coefficient |                 |     | 0.4  |     | mV/ $10^{\circ}\text{C}$ |
| Internal reference voltage                 |                 |     | 1.15 |     | V                        |

## DC CHARACTERISTICS

Measured on Texas Instruments CC2543EM reference design with  $T_A = 25^{\circ}\text{C}$ ,  $V_{DD} = 3\text{ V}$ , unless otherwise noted.<sup>(1)</sup>

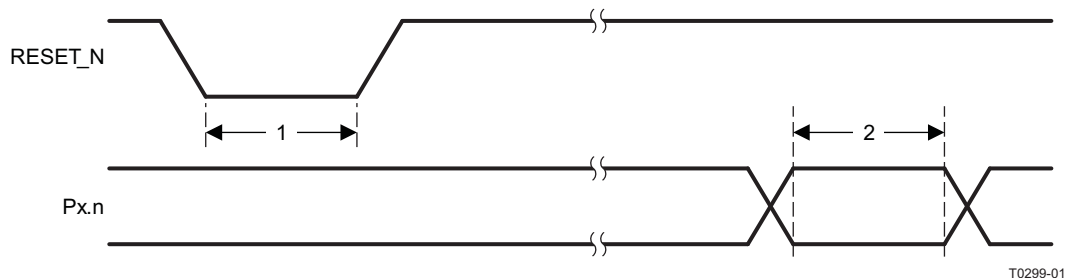
| PARAMETER                             | TEST CONDITIONS   | MIN | TYP | MAX | UNIT       |
|---------------------------------------|-------------------|-----|-----|-----|------------|
| Logic-0 input voltage                 |                   |     |     | 0.5 | V          |
| Logic-1 input voltage                 |                   | 2.5 |     |     | V          |
| Logic-0 input current                 |                   | –50 |     | 50  | nA         |
| Logic-1 input current                 |                   | –50 |     | 50  | nA         |
| I/O pin pullup and pulldown resistors |                   |     | 20  |     | k $\Omega$ |
| Logic-0 output voltage 4-mA pins      | Output load 4 mA  |     |     | 0.5 | V          |
| Logic-1 output voltage 4-mA pins      | Output load 4 mA  | 2.4 |     |     | V          |
| Logic-0 output voltage 20-mA pins     | Output load 20 mA |     |     | 0.5 | V          |
| Logic-1 output voltage 20-mA pins     | Output load 20 mA | 2.4 |     |     | V          |

(1) Note that only two of the three 20mA pins can drive in the same direction at the same time, and toggle at the same time.

## CONTROL INPUT AC CHARACTERISTICS

 $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ,  $V_{DD} = 2\text{ V}$  to  $3.6\text{ V}$ .

| PARAMETER                                                                      | TEST CONDITIONS                                                                                                                                                                                                                    | MIN | TYP | MAX | UNIT          |
|--------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|---------------|
| System clock, $f_{\text{SYSCLK}}$<br>$t_{\text{SYSCLK}} = 1/f_{\text{SYSCLK}}$ | The undivided system clock is 32 MHz when crystal oscillator is used.<br>The undivided system clock is 16 MHz when calibrated 16-MHz RC oscillator is used.                                                                        | 16  |     | 32  | MHz           |
| RESET_N low duration                                                           | See item 1, <a href="#">Figure 1</a> . This is the shortest pulse that is recognized as a complete reset pin request. Note that shorter pulses may be recognized but do not lead to complete reset of all modules within the chip. | 1   |     |     | $\mu\text{s}$ |
| Interrupt pulse duration                                                       | See item 2, <a href="#">Figure 1</a> . This is the shortest pulse that is recognized as an interrupt request.                                                                                                                      | 20  |     |     | ns            |

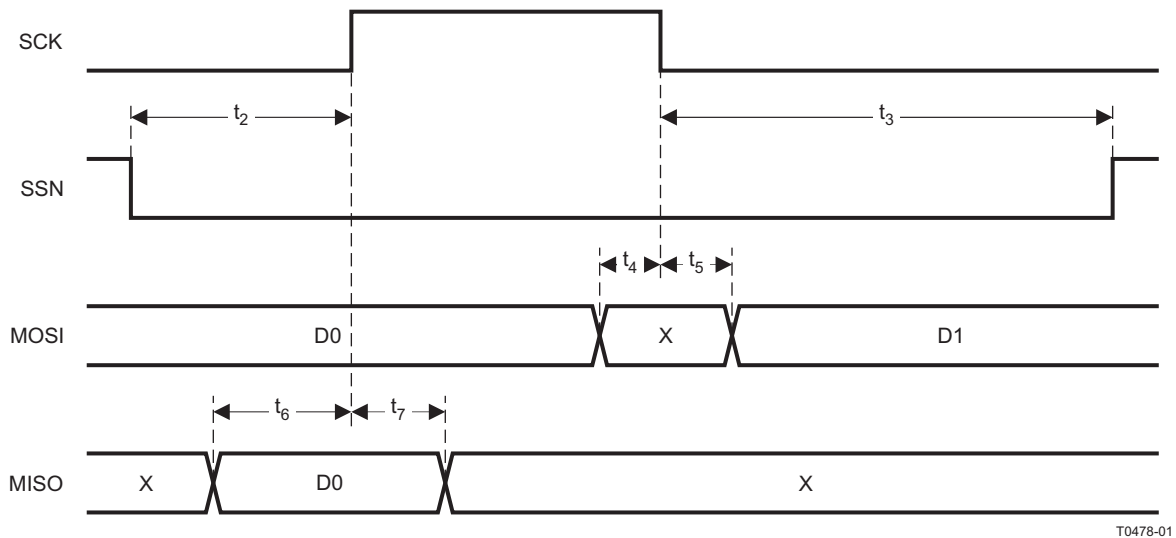


**Figure 1. Control Input AC Characteristics**

## SPI AC CHARACTERISTICS

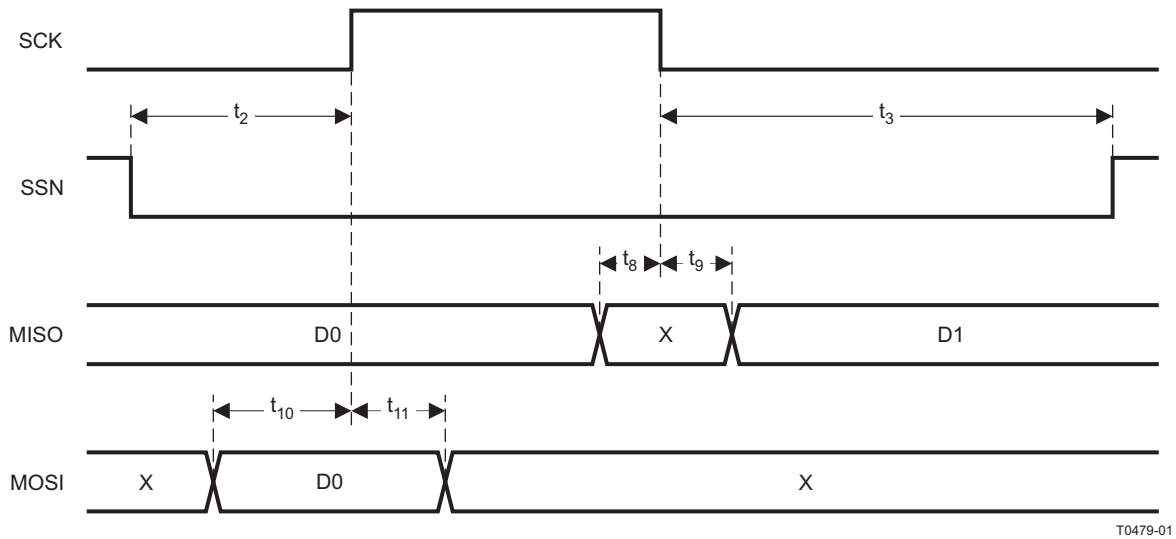
 $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ,  $V_{DD} = 2\text{ V}$  to  $3.6\text{ V}$ 

| PARAMETER           |                                                                       | TEST CONDITIONS      | MIN | TYP | MAX | UNIT |
|---------------------|-----------------------------------------------------------------------|----------------------|-----|-----|-----|------|
| $t_1$               | SCK period                                                            | Master, RX and TX    | 250 |     |     | ns   |
|                     |                                                                       | Slave, RX and TX     | 250 |     |     |      |
|                     | SCK duty cycle                                                        | Master               |     | 50% |     |      |
| $t_2$               | SSN low to SCK, <a href="#">Figure 2</a> and <a href="#">Figure 3</a> | Master               | 63  |     |     | ns   |
|                     |                                                                       | Slave                | 63  |     |     |      |
| $t_3$               | SCK to SSN high                                                       | Master               | 63  |     |     | ns   |
|                     |                                                                       | Slave                | 63  |     |     |      |
| $t_4$               | MOSI early out                                                        | Master, load = 10 pF |     |     | 7   | ns   |
| $t_5$               | MOSI late out                                                         | Master, load = 10 pF |     |     | 10  | ns   |
| $t_6$               | MISO setup                                                            | Master               | 90  |     |     | ns   |
| $t_7$               | MISO hold                                                             | Master               | 10  |     |     | ns   |
|                     | SCK duty cycle                                                        | Slave                |     | 50% |     | ns   |
| $t_{10}$            | MOSI setup                                                            | Slave                | 35  |     |     | ns   |
| $t_{11}$            | MOSI hold                                                             | Slave                | 10  |     |     | ns   |
| $t_8$               | MISO early out                                                        | Slave, load = 10 pF  |     |     | 0   | ns   |
| $t_9$               | MISO late out                                                         | Slave, load = 10 pF  |     |     | 95  | ns   |
| Operating frequency |                                                                       | Master, TX only      |     |     | 8   | MHz  |
|                     |                                                                       | Master, RX and TX    |     |     | 4   |      |
|                     |                                                                       | Slave, RX only       |     |     | 8   |      |
|                     |                                                                       | Slave, RX and TX     |     |     | 4   |      |



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**Figure 2. SPI Master AC Characteristics**

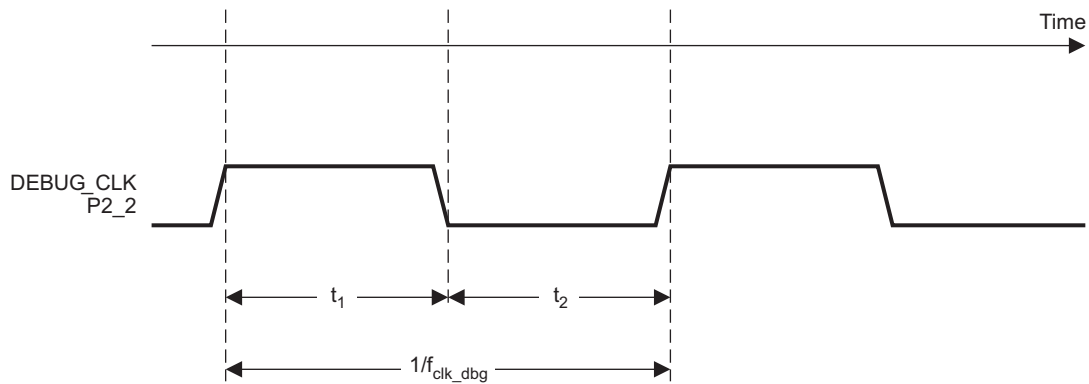


**Figure 3. SPI Slave AC Characteristics**

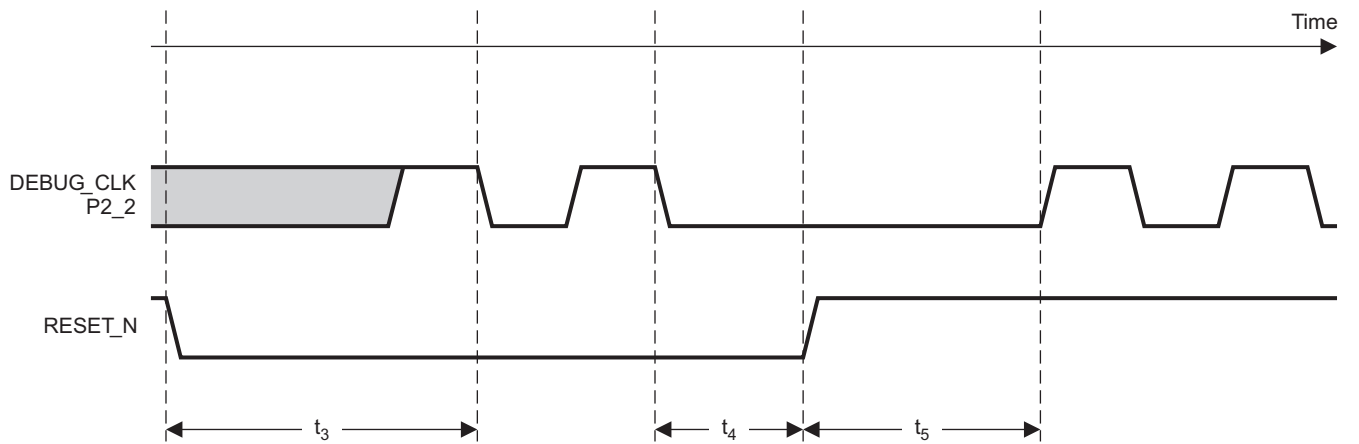
## DEBUG INTERFACE AC CHARACTERISTICS

$T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ,  $V_{DD} = 2\text{ V}$  to  $3.6\text{ V}$

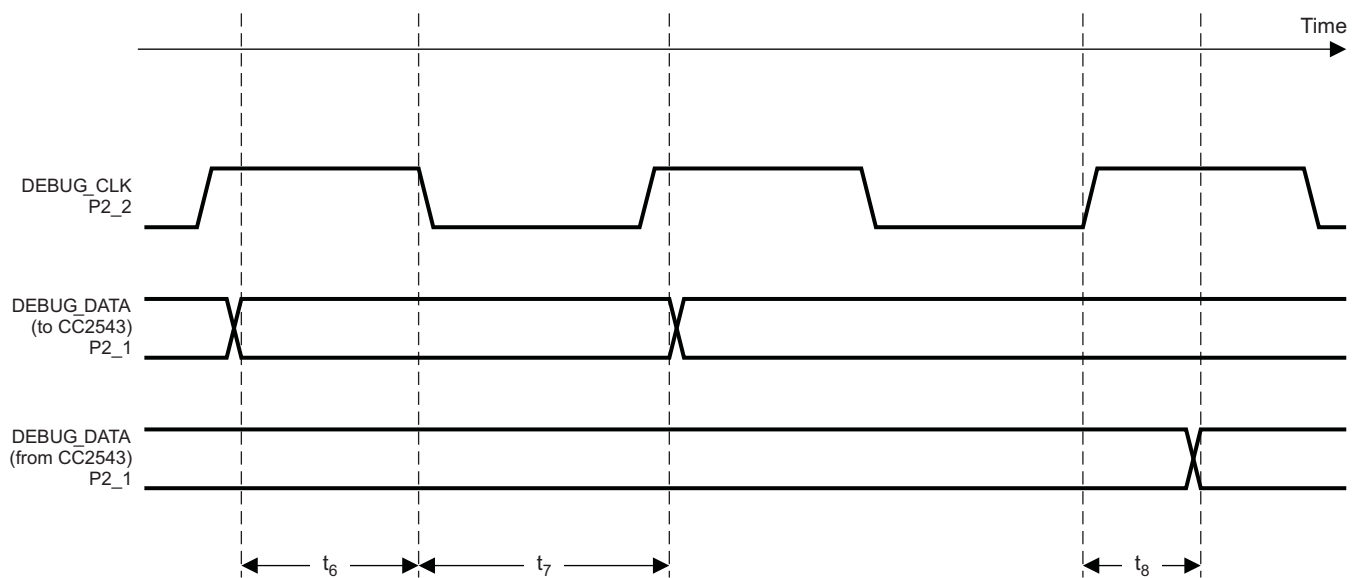
| PARAMETER                                                                 | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| $f_{\text{clk\_dbg}}$ Debug clock frequency (see Figure 4)                |                 |     |     | 12  | MHz  |
| $t_1$ Allowed high pulse on clock (see Figure 4)                          |                 | 35  |     |     | ns   |
| $t_2$ Allowed low pulse on clock (see Figure 4)                           |                 | 35  |     |     | ns   |
| $t_3$ EXT_RESET_N low to first falling edge on debug clock (see Figure 5) |                 | 167 |     |     | ns   |
| $t_4$ Falling edge on clock to EXT_RESET_N high (see Figure 5)            |                 | 83  |     |     | ns   |
| $t_5$ EXT_RESET_N high to first debug command (see Figure 5)              |                 | 83  |     |     | ns   |
| $t_6$ Debug data setup (see Figure 6)                                     |                 | 2   |     |     | ns   |
| $t_7$ Debug data hold (see Figure 6)                                      |                 | 4   |     |     | ns   |
| $t_8$ Clock-to-data delay (see Figure 6)                                  | Load = 10 pF    |     |     | 30  | ns   |



**Figure 4. Debug Clock – Basic Timing**



T0437-01

**Figure 5. Debug Enable Timing**


T0438-03

**Figure 6. Data Setup and Hold Timing**

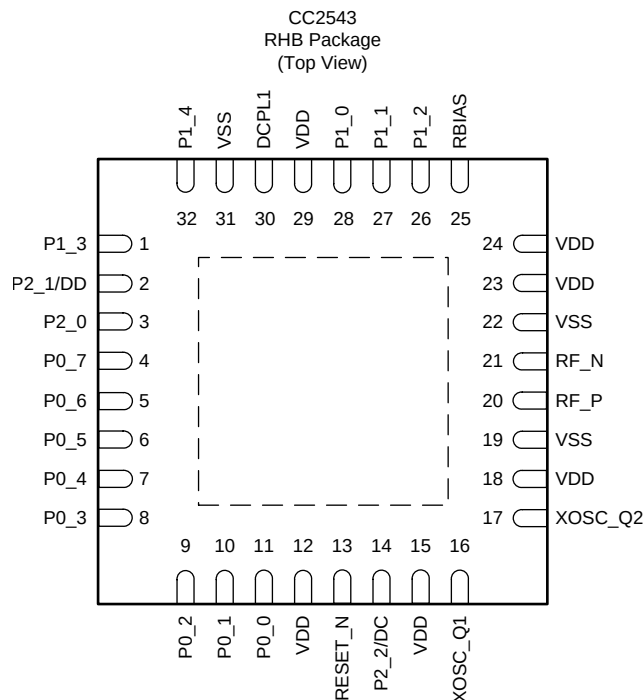
## TIMER INPUTS AC CHARACTERISTICS

 $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ,  $V_{DD} = 2\text{ V}$  to  $3.6\text{ V}$ 

| PARAMETER                    | TEST CONDITIONS                                                                                                                                         | MIN | TYP | MAX | UNIT                |
|------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|---------------------|
| Input capture pulse duration | Synchronizers determine the shortest input pulse that can be recognized. The synchronizers operate at the current system clock rate (16 MHz or 32 MHz). | 1.5 |     |     | $t_{\text{SYSCLK}}$ |

## DEVICE INFORMATION

### PIN DESCRIPTIONS



NOTE: The exposed ground pad must be connected to a solid ground plane; this is the main ground connection for the chip.

**Table 1. Pin Description Table**

| NAME    | PIN | PIN TYPE            | DESCRIPTION                                                                              |
|---------|-----|---------------------|------------------------------------------------------------------------------------------|
| P1_3    | 1   | Digital I/O         | Port 1.3                                                                                 |
| P2_1/DD | 2   | Digital I/O / Debug | Port 2.1 / Debug Data                                                                    |
| P2_0    | 3   | Digital I/O         | Port 2.0                                                                                 |
| P0_7    | 4   | Digital I/O         | Port 0.7                                                                                 |
| P0_6    | 5   | Digital I/O         | Port 0.6                                                                                 |
| P0_5    | 6   | Digital I/O         | Port 0.5                                                                                 |
| P0_4    | 7   | Digital I/O         | Port 0.4                                                                                 |
| P0_3    | 8   | Digital I/O         | Port 0.3                                                                                 |
| P0_2    | 9   | Digital I/O         | Port 0.2                                                                                 |
| P0_1    | 10  | Digital I/O         | Port 0.1                                                                                 |
| P0_0    | 11  | Digital I/O         | Port 0.0                                                                                 |
| VDD     | 12  | Power (analog)      | 2-V-3.6V analog power-supply connection                                                  |
| RESET_N | 13  | Digital input       | Reset, active-low                                                                        |
| P2_2/DC | 14  | Digital I/O / Debug | Port 2.2 / Debug Clock                                                                   |
| VDD     | 15  | Power (analog)      | 2-V-3.6V analog power-supply connection                                                  |
| XOSC_Q1 | 16  | Analog O            | 32-MHz crystal oscillator pin 1                                                          |
| XOSC_Q2 | 17  | Analog O            | 32-MHz crystal oscillator pin 2                                                          |
| VDD     | 18  | Power (analog)      | 2-V-3.6V analog power-supply connection                                                  |
| VSS     | 19  | Unused pin          | Connect to ground                                                                        |
| RF_P    | 20  | RF I/O              | Positive RF input signal to LNA during RX<br>Positive RF output signal from PA during TX |

**Table 1. Pin Description Table (continued)**

| NAME  | PIN        | PIN TYPE        | DESCRIPTION                                                                                                                |
|-------|------------|-----------------|----------------------------------------------------------------------------------------------------------------------------|
| RF_N  | 21         | RF I/O          | Negative RF input signal to LNA during RX<br>Negative RF output signal from PA during TX                                   |
| VSS   | 22         | Unused pin      | Connect to ground                                                                                                          |
| VDD   | 23         | Power (analog)  | 2-V–3.6-V analog power-supply connection                                                                                   |
| VDD   | 24         | Power (analog)  | 2-V–3.6-V analog power-supply connection                                                                                   |
| RBIAS | 25         | Analog I/O      | External precision bias resistor for reference current                                                                     |
| P1_2  | 26         | Digital I/O     | Port 1.2, 20 mA                                                                                                            |
| P1_1  | 27         | Digital I/O     | Port 1.1, 20 mA                                                                                                            |
| P1_0  | 28         | Digital I/O     | Port 1.0, 20 mA                                                                                                            |
| VDD   | 29         | Power (analog)  | 2-V–3.6-V analog power-supply connection                                                                                   |
| DCPL1 | 30         | Power (digital) | 1.8-V digital power-supply decoupling. Do not use for supplying external circuits.                                         |
| VSS   | 31         | Unused pin      | Connect to ground                                                                                                          |
| P1_4  | 32         | Digital I/O     | Port 1.4                                                                                                                   |
| VSS   | Ground pad | Ground          | Must be connected to solid ground as this is the main ground connection for the chip. See <a href="#">Pinout Diagram</a> . |

## BLOCK DIAGRAM

A block diagram of the CC2543 is shown in Figure 7. The modules can be roughly divided into one of three categories: CPU-related modules; modules related to power, test, and clock distribution; and radio-related modules. In the following subsections, a short description of each module is given. See CC2543/44/45 User's Guide (SWRU283) for more details.

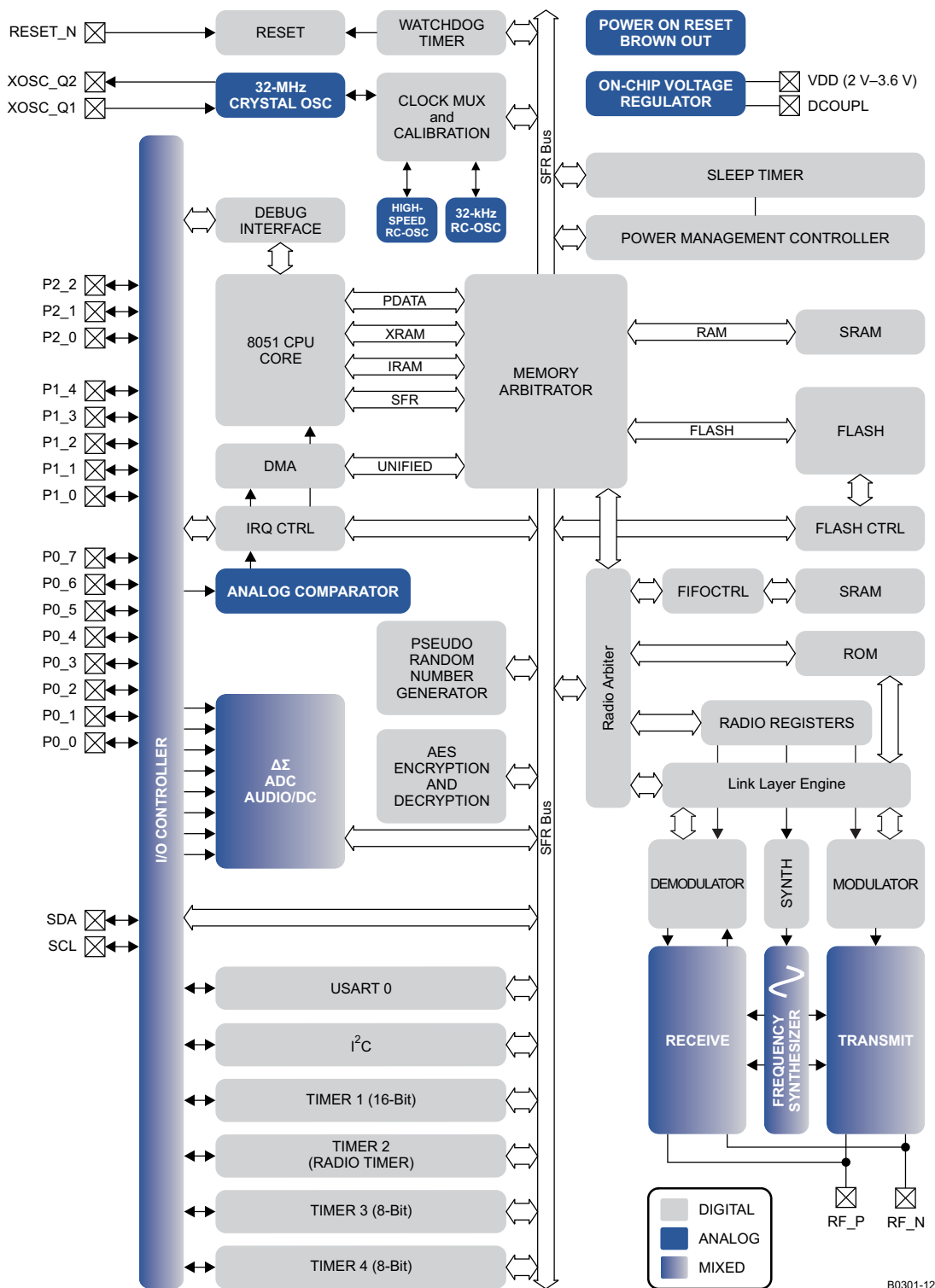


Figure 7. CC2543 Block Diagram

## BLOCK DESCRIPTIONS

### CPU and Memory

The **8051 CPU core** is a single-cycle 8051-compatible core. It has three different memory access busses (SFR, DATA, and CODE/XDATA), a debug interface, and an 15-input extended interrupt unit.

The **memory arbiter** is at the heart of the system, as it connects the CPU and DMA controller with the physical memories and all peripherals through the SFR bus. The memory arbiter has four memory-access points, access of which can map to one of three physical memories: an SRAM, flash memory, and XREG/SFR registers. It is responsible for performing arbitration and sequencing between simultaneous memory accesses to the same physical memory.

The **SFR bus** is drawn conceptually in [Figure 7](#) as a common bus that connects all hardware peripherals to the memory arbiter. The SFR bus in the block diagram also provides access to the radio registers in the radio register bank, even though these are indeed mapped into XDATA memory space.

The **1-KB SRAM** maps to the DATA memory space and to parts of the XDATA memory spaces.

The **18-KB/32-KB flash block** provides in-circuit programmable non-volatile program memory for the device, and maps into the CODE and XDATA memory spaces.

### Peripherals

Writing to the flash block is performed through a **flash controller** that allows page-wise erasure and 4-bytewise programming. See User Guide for details on the flash controller.

A versatile two-channel **DMA controller** is available in the system, accesses memory using the XDATA memory space, and thus has access to all physical memories. Each channel (trigger, priority, transfer mode, addressing mode, source and destination pointers, and transfer count) is configured with DMA descriptors that can be located anywhere in memory. Many of the hardware peripherals (AES core, flash controller, USART, timers, etc.) can be used with the DMA controller for efficient operation by performing data transfers between a single SFR or XREG address and flash/SRAM.

The **interrupt controller** services a total of 17 interrupt sources, divided into six interrupt groups, each of which is associated with one of four interrupt priorities. Any interrupt service request is serviced also when the device is in idle mode by going back to active mode. Some interrupts can also wake up the device from sleep mode (when in sleep mode, the device is in low-power mode PM1, PM2 or PM3).

The **debug interface** implements a proprietary two-wire serial interface that is used for in-circuit debugging. Through this debug interface, it is possible to perform an erasure of the entire flash memory, control which oscillators are enabled, stop and start execution of the user program, execute supplied instructions on the 8051 core, set code breakpoints, and single-step through instructions in the code. Using these techniques, it is possible to perform in-circuit debugging and external flash programming elegantly.

The **I/O controller** is responsible for all general-purpose I/O pins. The CPU can configure whether peripheral modules control certain pins or whether they are under software control, and if so, whether each pin is configured as an input or output and if a pullup or pulldown resistor in the pad is connected. Each peripheral that connects to the I/O pins can choose between several different I/O pin locations to ensure flexibility in various applications.

The **sleep timer** is an ultralow-power timer that uses an internal 32.753-kHz RC oscillator. The sleep timer runs continuously in all operating modes. Typical applications of this timer are as a real-time counter or as a wake-up timer to get out of power modes 1 or 2.

A built-in **watchdog timer** allows the CC2543 to reset itself if the firmware hangs. When enabled by software, the watchdog timer must be cleared periodically; otherwise, it resets the device when it times out.

**Timer 1** is a 16-bit timer with timer/counter/PWM functionality. It has a programmable prescaler, a 16-bit period value, and five individually programmable counter/capture channels, each with a 16-bit compare value. Each of the counter/capture channels can be used as a PWM output or to capture the timing of edges on input signals. It can also be configured in IR generation mode, where it counts timer 3 periods and the output is ANDed with the output of timer 3 to generate modulated consumer IR signals with minimal CPU interaction.



**Timer 2** is a 40-bit timer used by the Radio. It has a 16-bit counter with a configurable timer period and a 24-bit overflow counter that can be used to keep track of the number of periods that have transpired. A 40-bit capture register is also used to record the exact time at which a start-of-frame delimiter is received/transmitted or the exact time at which a packet ends. There are two 16-bit timer-compare registers and two 24-bit overflow-compare registers that can be used to give exact timing for start of RX or TX to the radio or general interrupts.

**Timer 3 and timer 4** are 8-bit timers with timer/counter/PWM functionality. They have a programmable prescaler, an 8-bit period value, and one programmable counter channel with an 8-bit compare value. Each of the counter channels can be used as PWM output.

**USART 0** is configurable as either an SPI master/slave or a UART. It provides double buffering on both RX and TX and hardware flow control and is thus well suited to high-throughput full-duplex applications. The USART has its own high-precision baud-rate generator, thus leaving the ordinary timers free for other uses. When configured as SPI slaves, the USART samples the input signal using SCK directly instead of using some oversampling scheme, and are thus well-suited for high data rates.

The **I<sup>2</sup>C** module provides a digital peripheral connection with two pins and supports both master and slave operation.

The **ADC** supports 7 bits (30 kHz bandwidth) to 12 bits (4 kHz bandwidth) of resolution. DC and audio conversions with up to eight input channels (Port 0) are possible. The inputs can be selected as single-ended or differential. The reference voltage can be internal, AVDD, or a single-ended or differential external signal. The ADC also has a temperature-sensor input channel. The ADC can automate the process of periodic sampling or conversion over a sequence of channels.

The **AES encryption/decryption core** allows the user to encrypt and decrypt data using the AES algorithm with 128-bit keys. The AES core also supports ECB, CBC, CFB, OFB, CTR, and CBC-MAC, as well as hardware support for CCM.

The ultralow-power **analog comparator** enables applications to wake up from PM2 or PM3 based on an analog signal. Both inputs are brought out to pins; the reference voltage must be provided externally. The comparator output is mapped into the digital I/O port and can be treated by the MCU as a regular digital input.

## TYPICAL CHARACTERISTICS

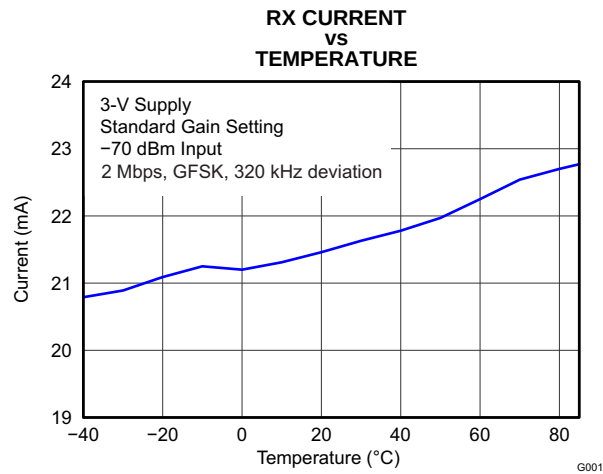


Figure 8.

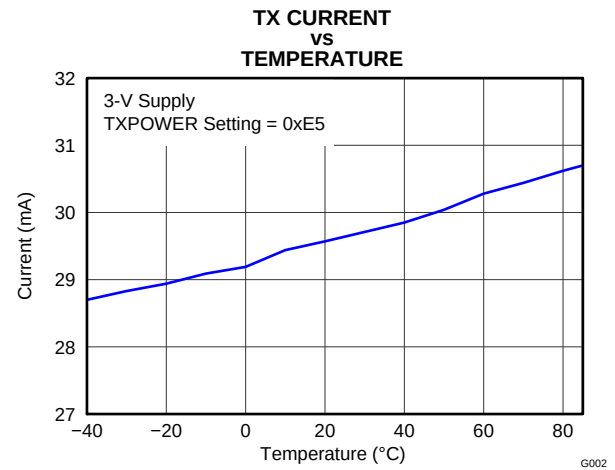


Figure 9.

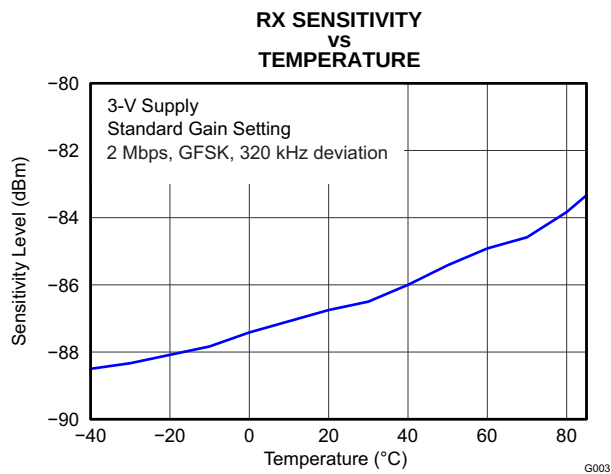


Figure 10.

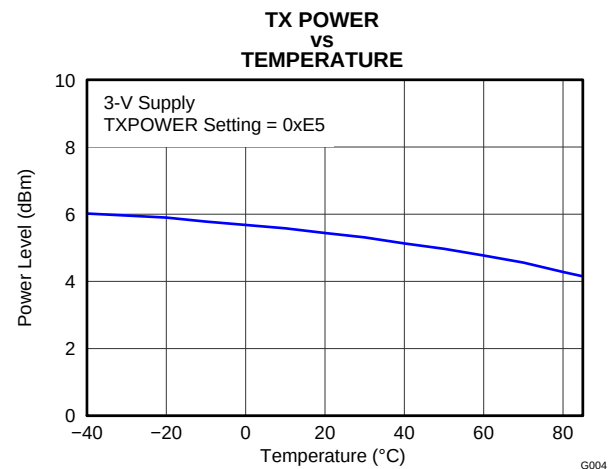


Figure 11.

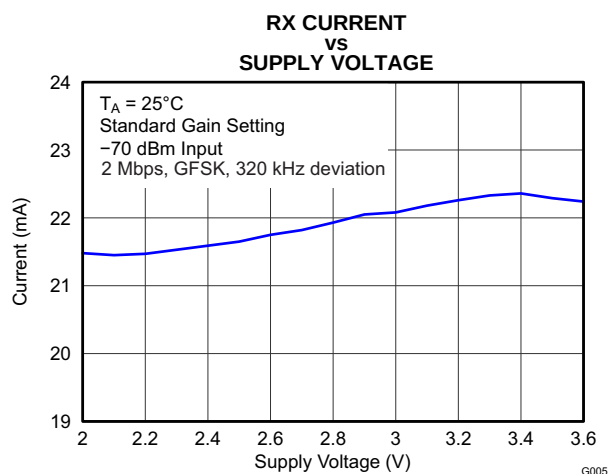


Figure 12.

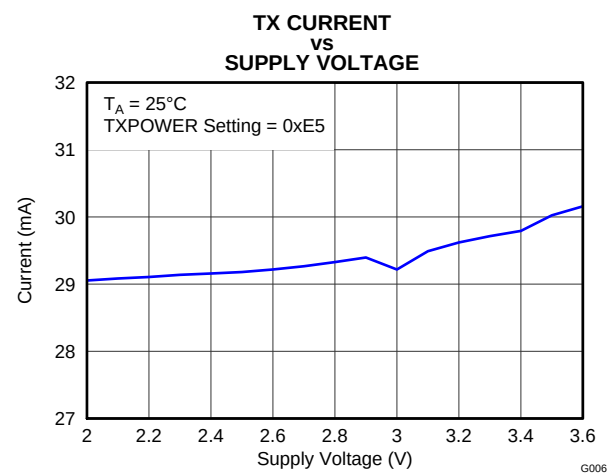


Figure 13.

## TYPICAL CHARACTERISTICS (continued)

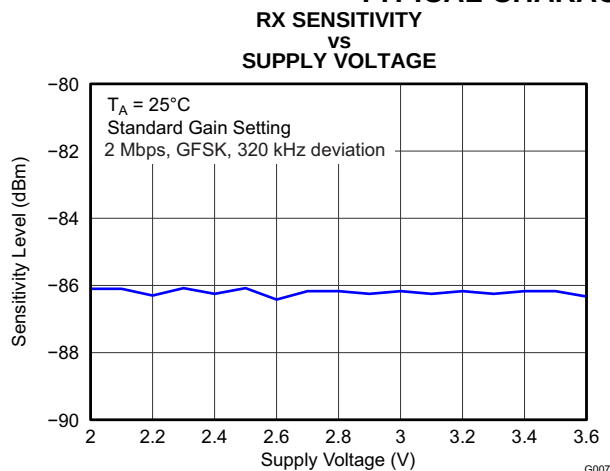


Figure 14.

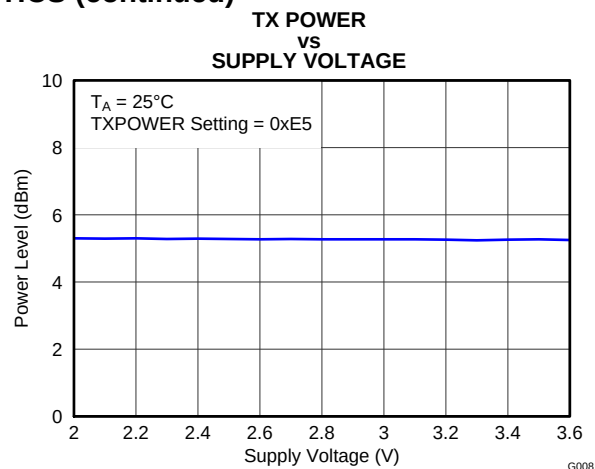


Figure 15.

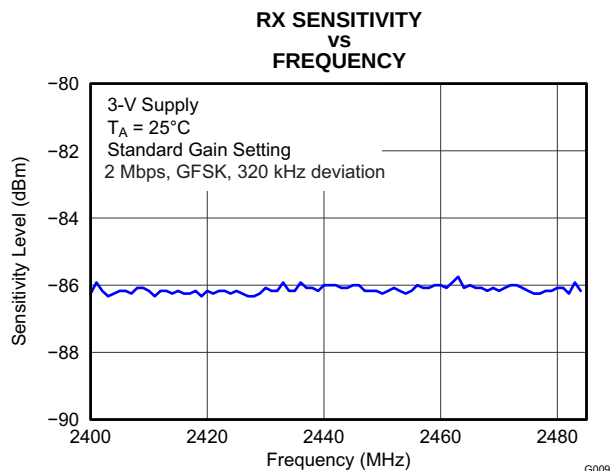


Figure 16.

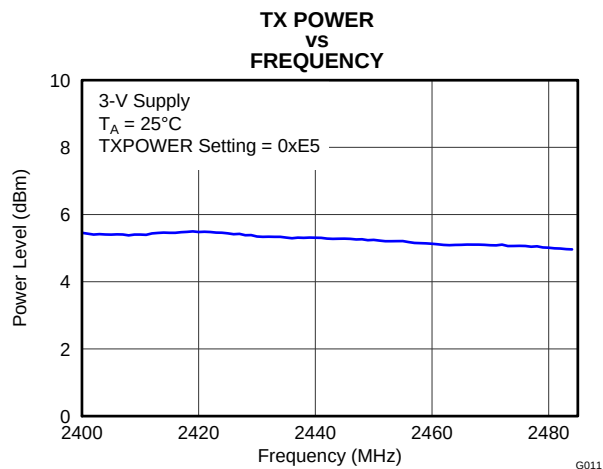


Figure 17.

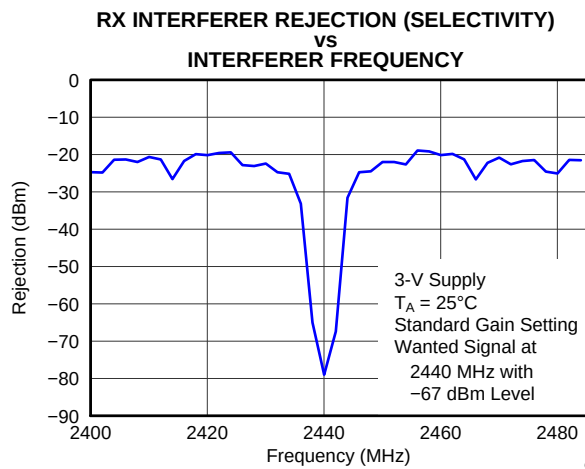


Figure 18.

**TYPICAL CHARACTERISTICS (continued)**  
**Table 2. Recommended Output Power Settings<sup>(1)</sup>**

| TXPOWER Register Setting | Typical Output Power (dBm) |
|--------------------------|----------------------------|
| 0xE5                     | 5                          |
| 0xD5                     | 4                          |
| 0xC5                     | 3                          |
| 0xB5                     | 2                          |
| 0xA5                     | 0                          |
| 0x95                     | –2                         |
| 0x85                     | –3                         |
| 0x75                     | –4                         |
| 0x65                     | –6                         |
| 0x55                     | –8                         |
| 0x45                     | –11                        |
| 0x35                     | –13                        |
| 0x25                     | –15                        |
| 0x15                     | –17                        |
| 0x05                     | –20                        |

- (1) Measured on Texas Instruments CC2543 EM reference design with TA = 25°C, VDD = 3 V and fc = 2440 MHz.  
See [SWRU283](#) for recommended register settings.

## APPLICATION INFORMATION

Few external components are required for the operation of the CC2543. A typical application circuit is shown in Figure 19. For suggestions of component values other than those listed in Table 3, see reference design CC2543EM. The performance stated in this data sheet is only valid for the CC2543EM reference design. To obtain similar performance, the reference design should be copied as closely as possible.

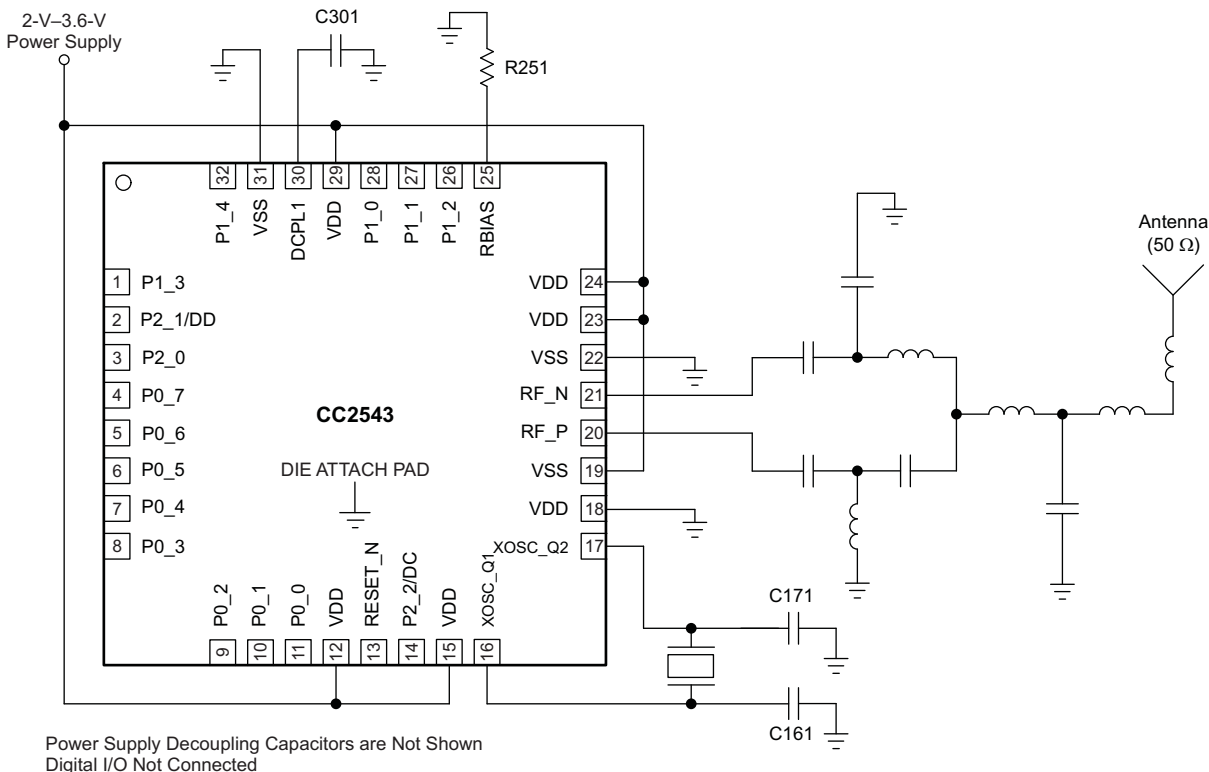


Figure 19. CC2543 Application Circuit

Table 3. Overview of External Components (Excluding Balun, Crystal and Supply Decoupling Capacitors)

| COMPONENT | DESCRIPTION                                                          | VALUE         |
|-----------|----------------------------------------------------------------------|---------------|
| C301      | Decoupling capacitor for the internal 1.8V digital voltage regulator | 1 $\mu$ F     |
| R251      | Precision resistor $\pm 1\%$ , used for internal biasing             | 56 k $\Omega$ |

### Input/Output Matching

When using an unbalanced antenna such as a monopole, a balun should be used to optimize performance. The balun can be implemented using low-cost discrete inductors and capacitors. See reference design, CC2543EM, for recommended balun.

## Crystal

An external 32-MHz crystal with two loading capacitors is used for the 32-MHz crystal oscillator. The load capacitance seen by the 32-MHz crystal is given by:

$$C_L = \frac{1}{\frac{1}{C_{161}} + \frac{1}{C_{171}}} + C_{\text{parasitic}} \quad (1)$$

A series resistor may be used to comply with ESR requirement.

## On-Chip 1.8-V Voltage Regulator Decoupling

The 1.8-V on-chip voltage regulator supplies the 1.8-V digital logic. This regulator requires a decoupling capacitor (C301) for stable operation.

## Power-Supply Decoupling and Filtering

Proper power-supply decoupling must be used for optimum performance. The placement and size of the decoupling capacitors and the power supply filtering are very important to achieve the best performance in an application. TI provides a compact reference design that should be followed very closely.

## REVISION HISTORY

| Changes from Original (April 2012) to Revision A                                                                         | Page |
|--------------------------------------------------------------------------------------------------------------------------|------|
| • Changed 将数据表的状态从产品预览改为生产数据 .....                                                                                       | 1    |
| Changes from Revision A (April 2012) to Revision B                                                                       | Page |
| • Added Comparator Characteristics specifications .....                                                                  | 7    |
| • Added ADC Characteristics specifications .....                                                                         | 8    |
| Changes from Revision B (May 2012) to Revision C                                                                         | Page |
| • Changed the Temperature coefficient Unit value From: mV/°C To: / 0.1°C .....                                           | 7    |
| Changes from Revision C (August 2012) to Revision D                                                                      | Page |
| • Changed the Pin Package From: RHM to: RHB .....                                                                        | 13   |
| Changes from Revision D (November 2012) to Revision E                                                                    | Page |
| • Changed the ADC CHARACTERISTICS Test Conditions From: VDD is voltage on AVDD5 pin To: VDD is voltage from supply ..... | 8    |

## PACKAGING INFORMATION

| Orderable part number      | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|----------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">CC2543RHBR</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | CC2543              |
| CC2543RHBR.A               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | CC2543              |
| <a href="#">CC2543RHBT</a> | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | CC2543              |
| CC2543RHBT.A               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | CC2543              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

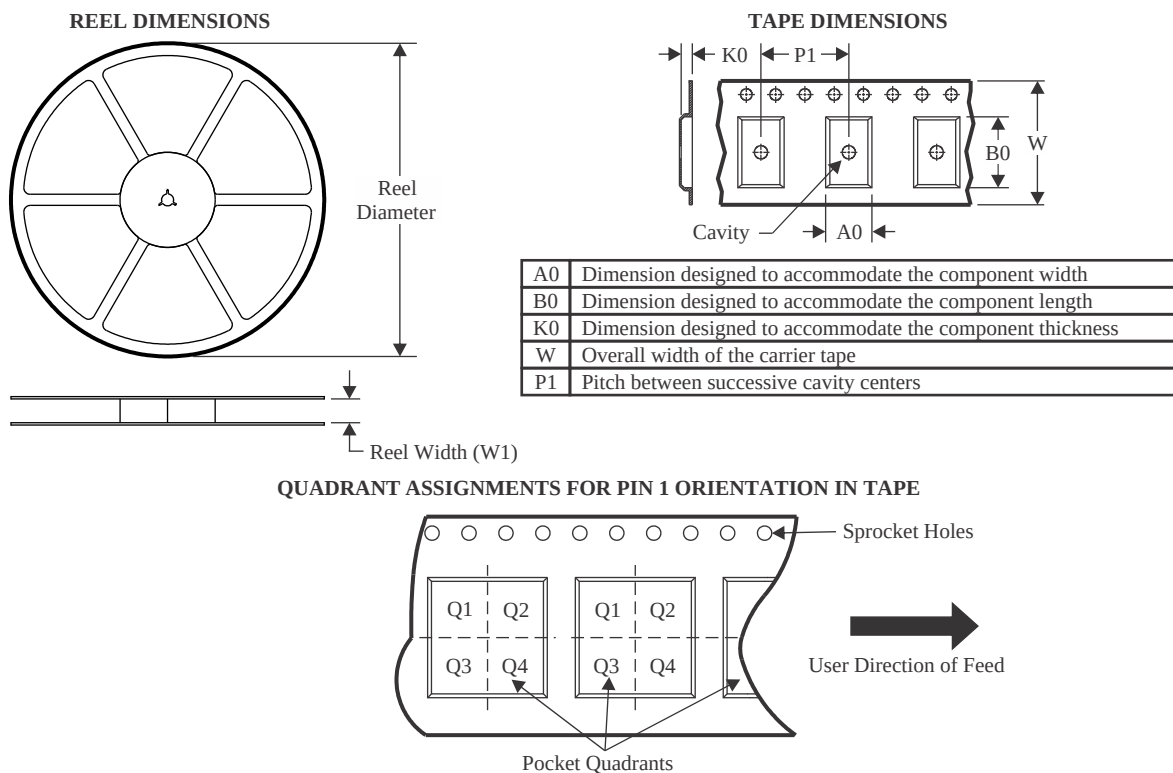
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION

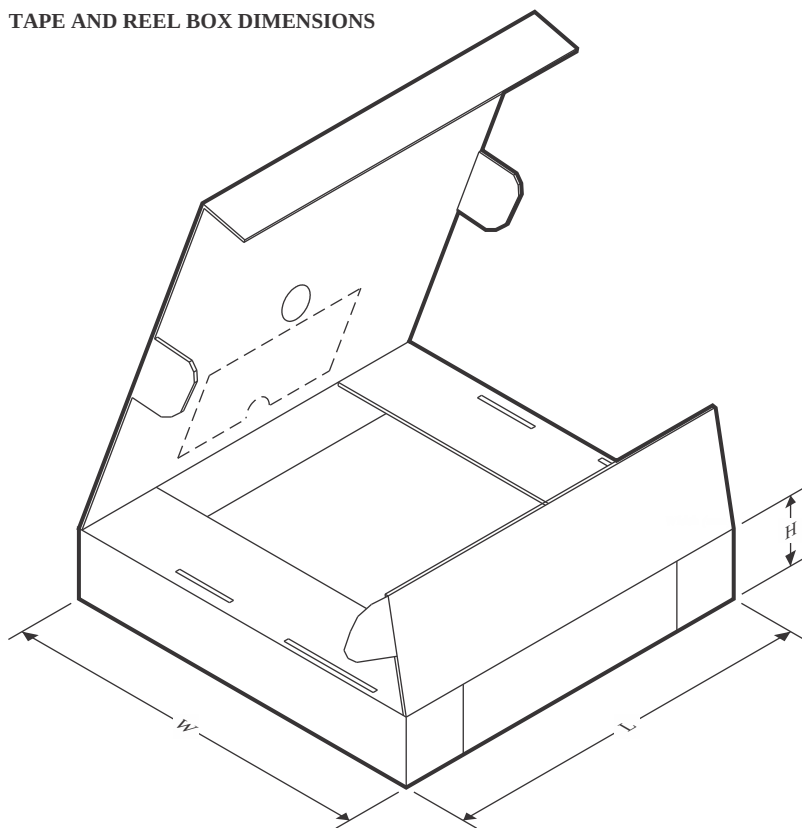


\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CC2543RHBR | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| CC2543RHBT | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |



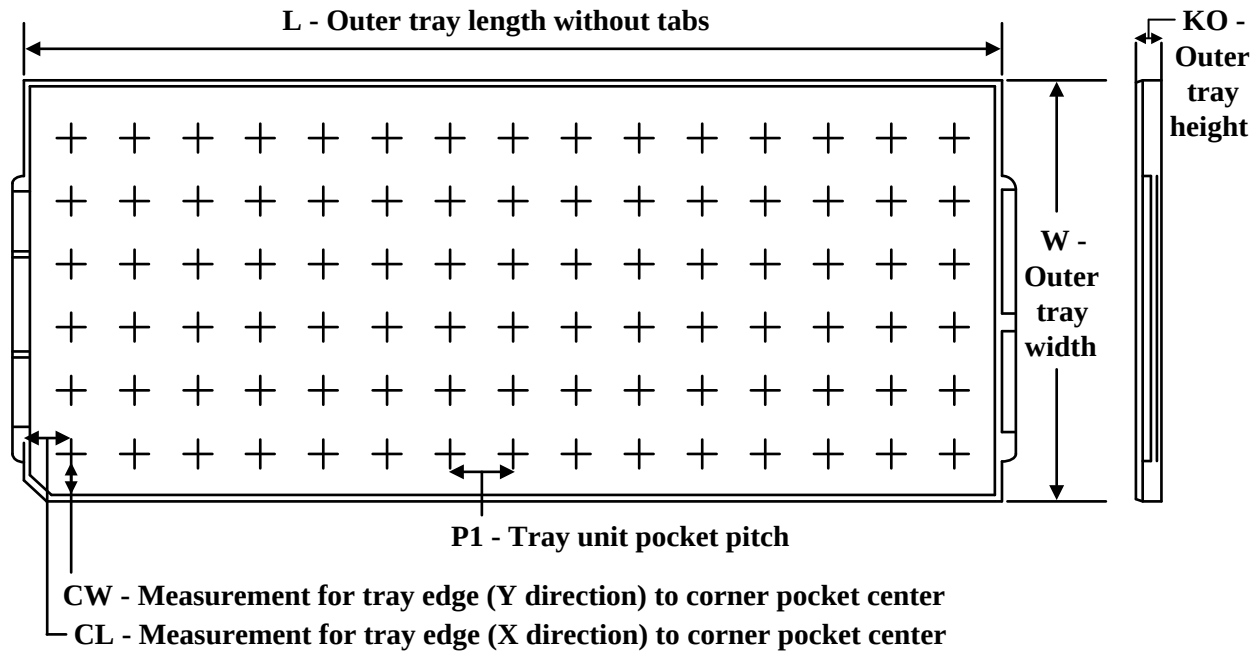
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CC2543RHBR | VQFN         | RHB             | 32   | 3000 | 350.0       | 350.0      | 43.0        |
| CC2543RHBT | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |

## TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

\*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ  | Unit array matrix | Max temperature (°C) | L (mm) | W (mm) | K0 (μm) | P1 (mm) | CL (mm) | CW (mm) |
|--------------|--------------|--------------|------|------|-------------------|----------------------|--------|--------|---------|---------|---------|---------|
| CC2543RHBR   | RHB          | VQFN         | 32   | 3000 | 14 x 35           | 150                  | 315    | 135.9  | 7620    | 8.8     | 7.9     | 8.15    |
| CC2543RHBR.A | RHB          | VQFN         | 32   | 3000 | 14 x 35           | 150                  | 315    | 135.9  | 7620    | 8.8     | 7.9     | 8.15    |

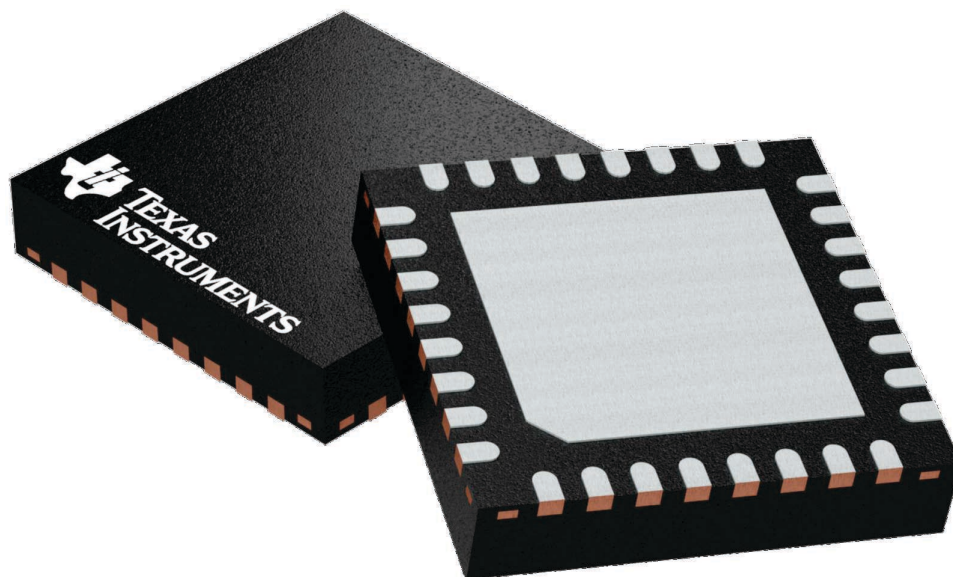
## GENERIC PACKAGE VIEW

**RHB 32**

**VQFN - 1 mm max height**

5 x 5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



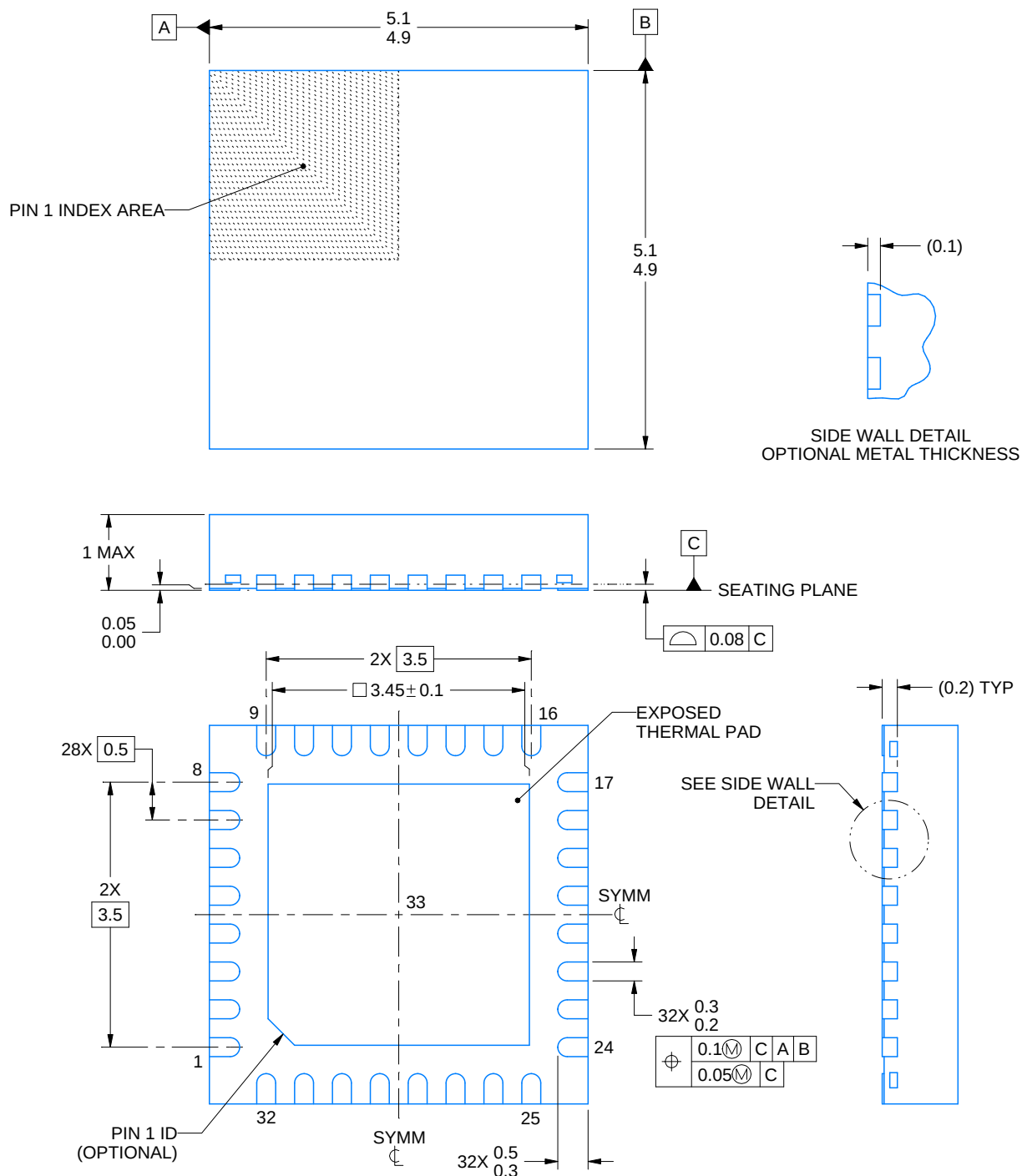
Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4224745/A



## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



4223442/B 08/2019

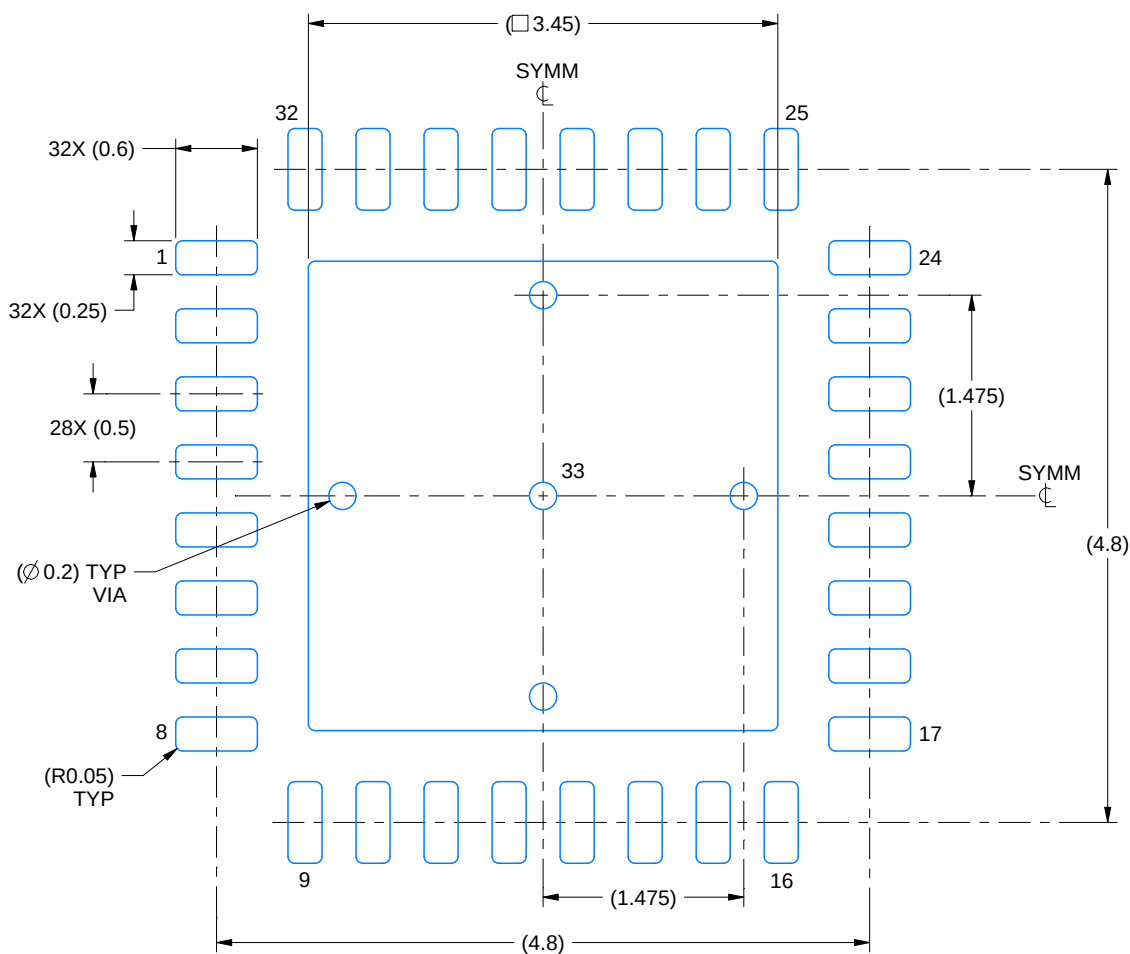
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

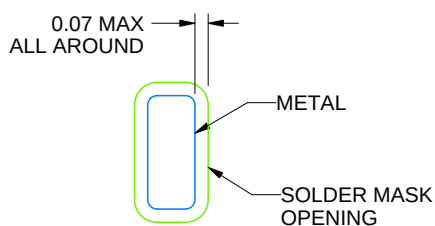
**RHB0032E**

### VQFN - 1 mm max height

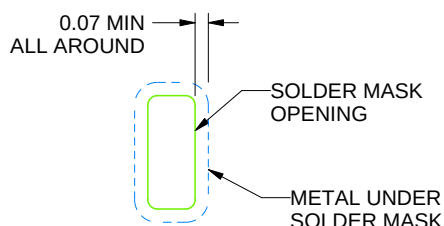
PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:18X



NON SOLDER MASK  
DEFINED  
(PREFERRED)



SOLDER MASK  
DEFINED

## SOLDER MASK DETAILS

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NOTES: (continued)

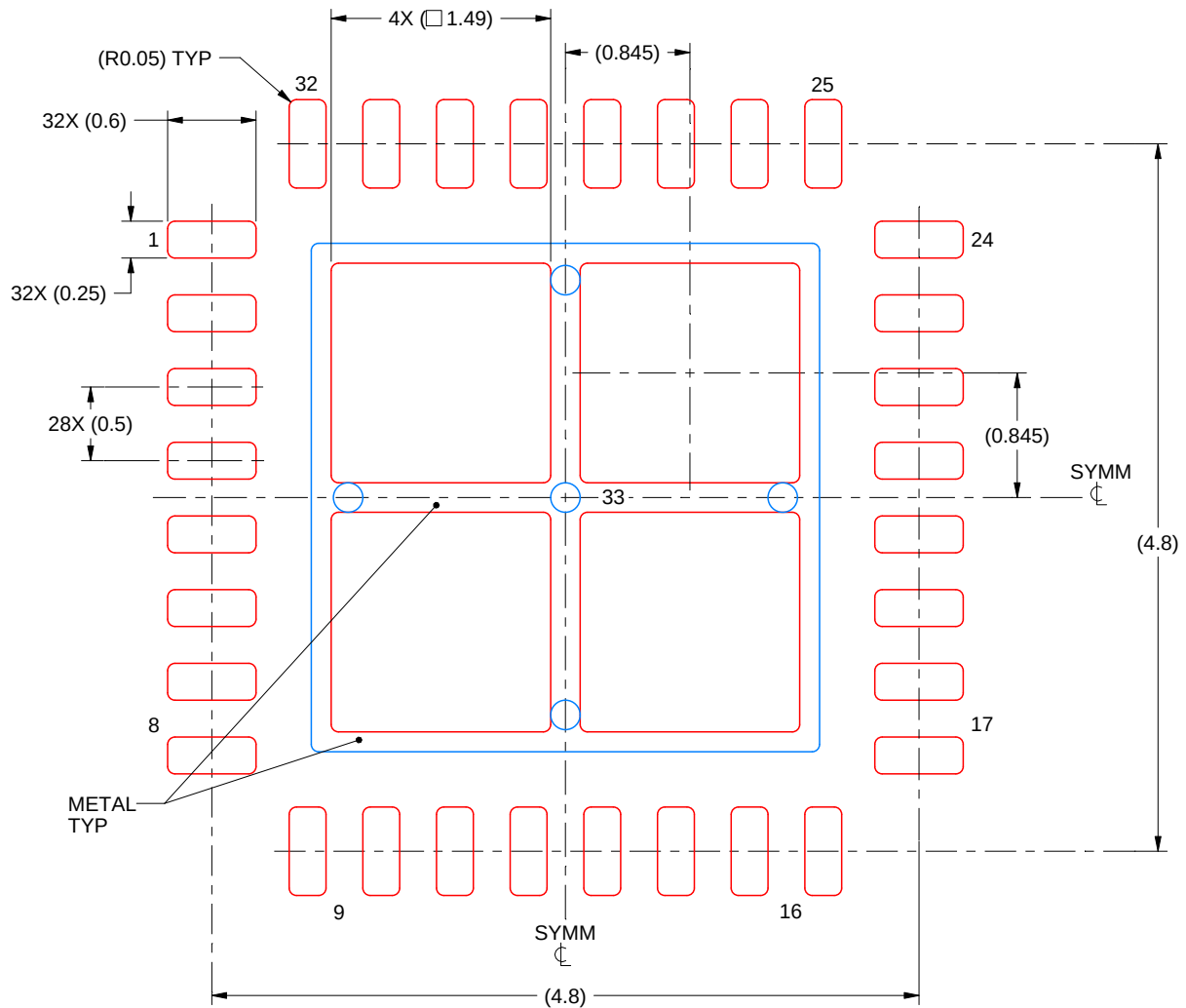
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RHB0032E

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 33:  
75% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

4223442/B 08/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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